

9-1734774-5 ✓ ACTIVE

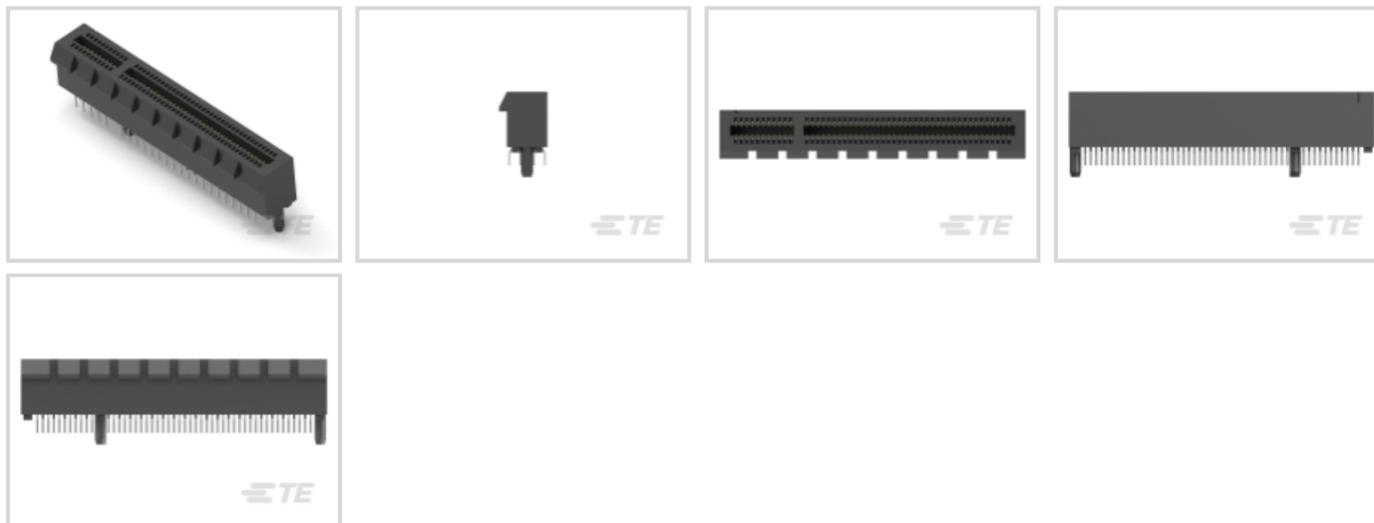


TE Internal #: 9-1734774-5

Cable-to-Board, 98 Position, 1 mm [.039 in] Centerline, Vertical,
Black, 10 mm [.394 in] Height, 8.8 mm [.346 in] Width, PCI & PCI
Express Connectors

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Connectors > PCB Connectors > Card Edge Connectors > PCI & PCI Express Connectors



Connector System: **Cable-to-Board**

Number of Positions: **98**

PCI Generation: **2**

Centerline (Pitch): **1 mm [.039 in]**

Termination Post & Tail Length: **2.3 mm [.091 in]**

Features

Product Type Features

Connector & Contact Terminates To	Printed Circuit Board
Connector System	Cable-to-Board

Configuration Features

Number of PCB Mount Retention Features	2
Number of Positions	98
PCB Mount Orientation	Vertical
Ejector	Without

Electrical Characteristics

Operating Voltage	50 VAC
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Body Features

Product Weight	5.5 g [.194 oz]
Primary Product Color	Black

Contact Features

Contact Current Rating (Max)	1.1 A
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PCB Contact Termination Area Plating Material Thickness	2.54 μ m
Contact Mating Area Plating Material	Gold (Au)
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin
PCB Contact Termination Area Plating Material Finish	Matte
Contact Mating Area Plating Material Thickness	.76 μ m[30 μ in]

Termination Features

Termination Method to PCB	Through Hole - Solder
Termination Post & Tail Length	2.3 mm[.091 in]

Mechanical Attachment

Connector Mounting Type	Board Mount
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Housing Features

Housing Material	PA 46
Centerline (Pitch)	1 mm[.039 in]

Dimensions

PCB Thickness (Recommended)	1.6 mm[.063 in]
PCB Thickness (Accepted)	1.57 mm[.062 in]
Connector Length	56 mm[2.205 in]
Connector Height	10 mm[.394 in]
Connector Width	8.8 mm[.346 in]

Usage Conditions

Operating Temperature Range	-40 – 85 °C[-40 – 185 °F]
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Industry Standards

Bus Type	PCI Express
PCI Generation	2

Packaging Features

Packaging Method	Box & Tray, Tray
Packaging Quantity	40

Product Compliance

For compliance documentation, visit the product page on [TE.com](#)>

EU RoHS Directive 2011/65/EU	Compliant
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EU ELV Directive 2000/53/EC	Not Yet Reviewed
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

Compatible Parts



TE Part # 5-2337939-4
PCIE GEN4 CON,SMT,164POS,30u", MYLAR,HT



TE Part # 1734774-1
PCI EXP 3.1L 36 POS WHT G/F

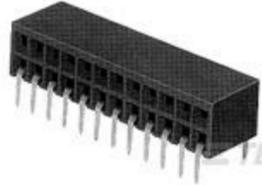
Customers Also Bought



TE Part #CAT-PF6-LO
IL 13, IL 13 P, IL 19



TE Part #ASA559N00820100000
623 PLUG, SPEEDTEC



TE Part #1-216604-7
2X17P HV190FEDERLEI



TE Part #8-338728-4
MICROM. MOB SMD CON



Documents

CAD Files

[3D PDF](#)

[3D](#)

[Customer View Model](#)

[ENG_CVM_CVM_9-1734774-5_F.2d_dxf.zip](#)

English

[Customer View Model](#)

[ENG_CVM_CVM_9-1734774-5_F.3d_igs.zip](#)

English

[Customer View Model](#)

[ENG_CVM_CVM_9-1734774-5_F.3d_stp.zip](#)

English

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Product Specifications

[Product Specification](#)

English